

#### Description

The IRFH5302TRPBF uses advanced trench technology

to provide excellent  $\,R_{\text{DS}(\text{ON})},$  low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

### **General Features**

V<sub>DS</sub> = 30V I<sub>D</sub> =150A

 $R_{DS(ON)} < 2.4 m\Omega V_{GS} = 10V$ 

## Application

Battery protection

Load switch

Uninterruptible power supply

#### Package Marking and Ordering Information

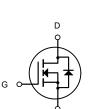
Product ID	Pack	Marking	Qty(PCS)		
IRFH5302TRPBF	DFN5X6-8L	FH5302 XXXX	5000		

#### Absolute Maximum Ratings (Tc=25 °C unless otherwise noted)

Symbol	Parameter	Rating	Units		
Vds	Drain-Source Voltage	ltage 30			
Vgs	Gate-Source Voltage	±20	V		
l₀@Tc=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	150	А		
I⊳@Tc=100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	80	А		
Ідм	Pulsed Drain Current <sup>2</sup>	160	А		
EAS	Single Pulse Avalanche Energy <sup>3</sup>	180	mJ		
las	Avalanche Current	60	А		
PD@Tc=25°C	Total Power Dissipation <sup>4</sup>	Total Power Dissipation <sup>4</sup> 187			
Тѕтс	Storage Temperature Range -55 to 150		°C		
TJ	T <sub>J</sub> Operating Junction Temperature Range -55 to		°C		
Reja	Thermal Resistance Junction-Ambient <sup>1</sup> 62		°C/W		
Rejc	Thermal Resistance Junction-Case <sup>1</sup>	1.1	°C/W		



DFN5X6-8L



N-Channel MOSFET

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V	
$\triangle BV_{\text{DSS}} / \triangle T_{\text{J}}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C,I <sub>D</sub> =1mA		0.014		V/°C	
Rds(on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =30A		2	2.4	mΩ	
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A		2.5	3.2		
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.2		2.5	V	
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	−−−V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		-4		mV/°C	
I <sub>DSS</sub>	Drain Source Lookage Current	$V_{DS}$ =24V , $V_{GS}$ =0V , $T_J$ =25°C			1		
	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA	
lgss	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =30A		50		S	
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω	
Qg	Total Gate Charge (4.5V)			56.9			
Qgs	Gate-Source Charge	V <sub>DS</sub> =15V , V <sub>GS</sub> =10V , I <sub>D</sub> =15A		13.8		nC	
$Q_{gd}$	Gate-Drain Charge			23.5			
T <sub>d(on)</sub>	Turn-On Delay Time			20.1			
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =3.3 $\Omega$ ,		6.3			
$T_{d(off)}$	Turn-Off Delay Time	I <sub>D</sub> =1A		124.6		ns	
T <sub>f</sub>	Fall Time			15.8			
Ciss	Input Capacitance			4345			
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		340		pF	
Crss	Reverse Transfer Capacitance			225			
ls	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			150	А	
Vsd	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V	

## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Note :

1. The data tested by surface mounted on a 1 inch $^2$  FR-4 board with 2OZ copper.

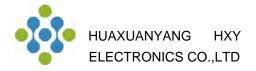
2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =60A

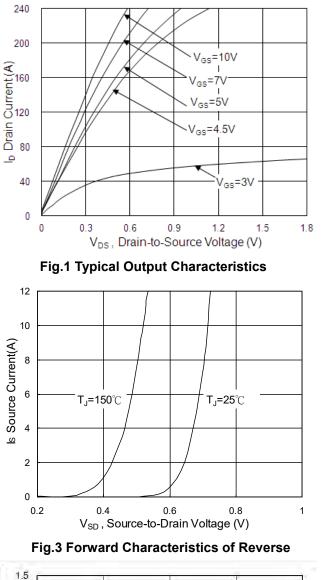
4. The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

6.Package limitation current is 85A.



## **Typical Characteristics**



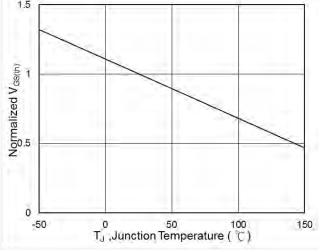


Fig.5 Normalized  $V_{GS(th)}$  v.s T<sub>J</sub>

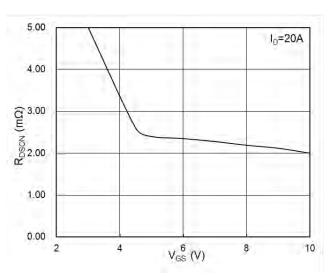


Fig.2 On-Resistance v.s Gate-Source

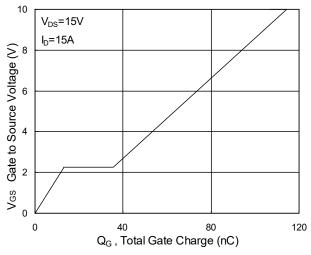


Fig.4 Gate-Charge Characteristics

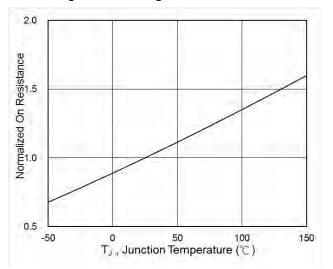


Fig.6 Normalized R<sub>DSON</sub> v.s T<sub>J</sub>



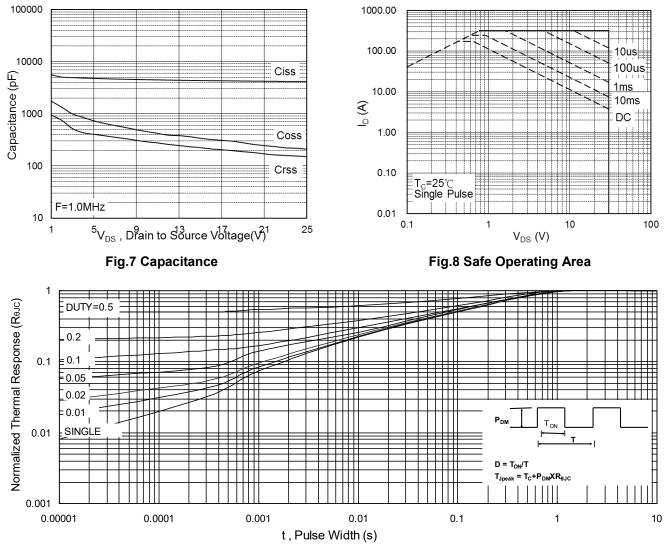
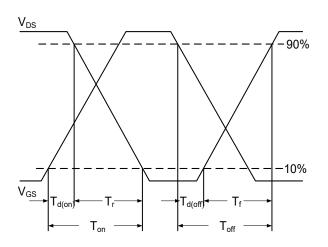
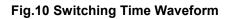


Fig.9 Normalized Maximum Transient Thermal Impedance





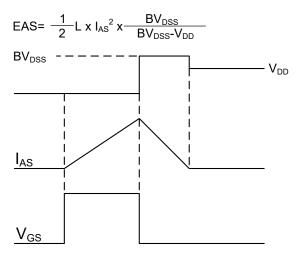
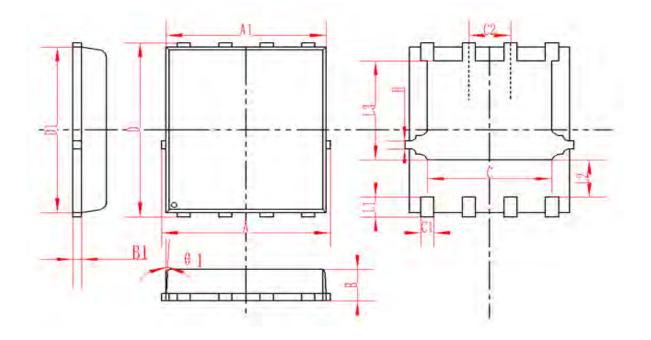


Fig.11 Unclamped Inductive Switching Waveform



# DFN5X6-8L Package Information



SYMBOL		MM			INCH	
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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